

SUPER STACK: MIT - MTT - RBL



MIT: Multi-Finger Imaging Tool

MTT: Magnetic Thickness Tool

RBL: Radial Bond Log

Description:

The Super Stack allows for OD/ID Casing Inspection and Radial Bond Log evaluation all in **one run**, saving time and money. The Magnetic Thickness Tool (MTT), Multi-Finger Imaging Tool (MIT), and Slim Hole Radial Bond Tool (Slim RBL) are designed to utilize both Surface Read Out (SRO) and Memory. This allows for multiple deployment options, including E-line, Slickline, Coil Tubing, etc.

Features:

- Casing Inspection (OD and ID) and RBL for a full well profile in **one run**
- Full memory and surface readout available
- Slim hole design (1 11/16") allows for through-tubing applications
- Hostile environment (H₂S / CO₂ rated)
- Expandable finger lengths for larger tubulars

	MIT-24	MIT-40	MIT-60	MTT	Slim RBL
# Sensors	24	40	60	12	1x3' 1x5' 6xR
Temperature	177°C	177°C	177°C	150°C	177°C
Pressure	103 MPa	138 MPa	138 MPa	103 MPa	138 MPa
Tool OD	43 mm	70 mm	99 mm	43 mm	43 mm
Length	1.64 m	1.68 m	1.55 m	2.18 m	3.03 m
Weight	9.4 kg	31.8 kg	43.5 kg	13.6 kg	18.1 kg
ID Range	50-178 mm	100-178 mm 245 mm extd	102-254 mm	50-178 mm	50-178 mm
Log Speed	10 m/min	10 m/min	10 m/min	10 m/min	10 m/min
H ₂ S / CO ₂	yes	yes	yes	yes	yes
Memory	yes	yes	yes	yes	yes